

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3038643

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HIROSHI KAWASHIMA	08/21/2014
JUN MUTO	09/05/2014
TAKAHIRO HIRANO	09/05/2014
RECEIVING PARTY DATA	
Name:	SUMIDA CORPORATION
Street Address:	SUITENGU HOKUSHIN BUILDING
Internal Address:	1-39-5, NIHONBASHI KAKIGARA-CHO
City:	CHUO-KU, TOKYO
State/Country:	JAPAN
Postal Code:	103-8589
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14496597
CORRESPONDENCE DATA	
Fax Number:	(860)286-0115
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	860-286-2929
Email:	usptopatentmail@cantorcolburn.com
Correspondent Name:	CANTOR COLBURN LLP
Address Line 1:	20 CHURCH STREET
Address Line 2:	22ND FLOOR
Address Line 4:	HARTFORD, CONNECTICUT 06103
ATTORNEY DOCKET NUMBER:	IWP0097US
NAME OF SUBMITTER:	DANIEL P. LENT
SIGNATURE:	/Daniel P. Lent/
DATE SIGNED:	09/25/2014
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 2	
source=7A54674#page1.tif	

ASSIGNMENT

WHEREAS We, **Hiroshi KAWASHIMA** of c/o **SUMIDA CORPORATION**, 31-1, Aza-Miyajima, Uematsu, Natori-city, Miyagi, 981-1226 Japan and **Jun MUTO** and **Takahiro HIRANO** of c/o **TOYOTA JIDOSHA KABUSHIKI KAISHA**, 1, Toyota-cho, Toyota-shi, Aichi-ken, 471-8571 Japan (hereinafter referred to as "ASSIGNORS") have invented certain new and useful improvements in:

COIL PART

which claims priority to **Japanese** Application No. **2013-213912**, filed **October 11, 2013**, and for which I am about to file or have filed an application for Letters Patent of the United States;

AND WHEREAS, **SUMIDA CORPORATION**, a corporation organized and existing under the laws of the Country of **JAPAN**, having a place of business at **Suitengu Hokushin Building, 1-39-5, Nihonbashi Kakigara-cho, Chuo-ku, Tokyo, 103-8589** and **TOYOTA JIDOSHA KABUSHIKI KAISHA**, a corporation organized and existing under the laws of the Country of **JAPAN**, having a place of business at **1, Toyota-cho, Toyota-shi, Aichi-ken, 471-8571 Japan**, (hereinafter referred to as "ASSIGNEES"), is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEES, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEES, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEES, its successors and assigns; and We do hereby agree

that the said ASSIGNEES, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEES, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEES fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: August 21, 2014 Hiroshi Kawashima L.S.
Hiroshi KAWASHIMA

Date: September 5, 2014 Jun Muto L.S.
Jun MUTO

Date: September 5, 2014 Takahiro Hirano L.S.
Takahiro HIRANO